Winning customers, winning products, winning vision

Scott McGregor

President and Chief Executive Officer Semiconductor Division

Agenda for today

- Winning customers, winning products, winning vision
 - Scott McGregor, President and CEO
- Winning strategy Consumer
 - Leon Husson, Executive Vice President
- Winning strategy Communications
 - Mario Rivas, Executive Vice President
- Winning strategy MultiMarket Semiconductors
 - Indro Mukerjee, Executive Vice President
- Summary and round-up



Today our CUSTOMERS tell you about us

Last year we demonstrated new products

2 years ago we talked about our technology



Winning customers, winning products, winning vision



Customers
Technology
Products
Manufacturing
Managing the downturn



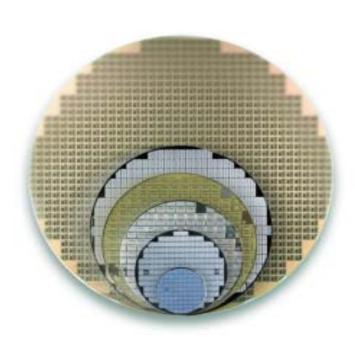
Customers
China
Manufacturing
Nexperia
Growth opportunities





Leading silicon solution company

- Top-10 supplier with revenues of \$4.4 billion in 2001
- Focus on silicon systems and multimarket semiconductors for: Communications, Consumer, Automotive, Computing
- 32,500 employees
- Global organization (18 manufacturing centers, 30 design centers, 4 systems labs and over 100 sales offices)
- 50 years' experience in semiconductors







Outstanding customer base

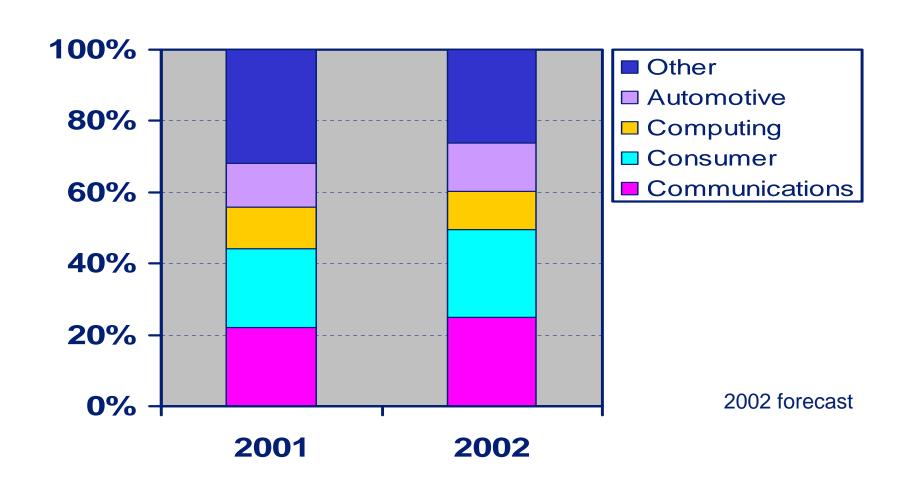
Communications	Consumer	Computing Automotive	Distributors	EMS
SAMSUNG	PHILIPS	PHILIPS SIEMENS		FLEXTRONICS
NOKIA	SAMSUNG ELECTRONICS	BOSCH	MOUNT.	SOLECTRON.
Sony Ericsson	SONY	Beng	AVNET®	SCI Bystems, Inc.
SIEMENS	CHANGHONG	47		
<i>Cell</i> •n		IBM.		
Card Systems GEMPLUS	Thomson	Visteor		
GEMIPLUS Giesecke & Devrient	National Panasonic Matsushita Electric	DELL DELL		

emiconductors





Market segmentation







- Our brand for application specific System on Chip and software solutions for all markets we address
- Nexperia system solutions are built on a unique architecture and make use of our extensive IP library - enabling efficient and cost effective designs
- Brand values: flexibility, fast time-to-market, innovation and future-proof

Differentiating technology

- Leadership Nexperia platform
 - Solutions for Video and Mobile applications
 - Shipping now in every DVD+RW player and in GSM system solutions



- Continuing excellence in RF & Analog
 - QUBiC4 low cost, high performance RF
 - 0.18 µm non-volatile EE/Flash and encryption technology for smart cards
- And now, best-in-class CMOS
 - 120 nm now, 90 nm by end-2002, 65 nm first silicon in 2003
 - 300 mm pilot line in 2003



Great products create leading positions

#1 with >35% share

Communication **Cordless** #1 with> 21% share

Bluetooth #1 with >21% share Wireless connectivity #2 with >11% share

Mobile handsets #4 with >10% share





Consumer TV

Media access (tuners / decoders) #1 with >60% share **DVD** recorder #1 with >35% share #2 with >18% share **Digital audio**





Automotive

In-vehicle networking #1 with >50% share In-car radio #1 with >30% share Car access & immobilizers #1 with >60% share Car DSP #1 with >60% share





Computing

CRT monitor drivers #1 with >30% share #2 with >25% share **Display drivers (small panels)** #2 with >30% share PC Add-on cards





Other

RF discretes, CATV #1 with >70% share Identification #2 with >20% share **MultiMarket Semiconductors** #4 with >4% share





Great products + great technologies





OVERV

Global manufacturing, assembly and test







Global manufacturing infrastructure

IC Capacity

- 2 million wafers per year (8 inch equivalent)
 - 20% BiCMOS, 25% Bipolar, 55% CMOS
- 170 billion pins assembly capacity

Discretes

- 1.2 million wafers per year (6 inch equivalent)
- 45 billion pieces assembly capacity

Partnerships

TSMC & Amkor



Environmental leadership

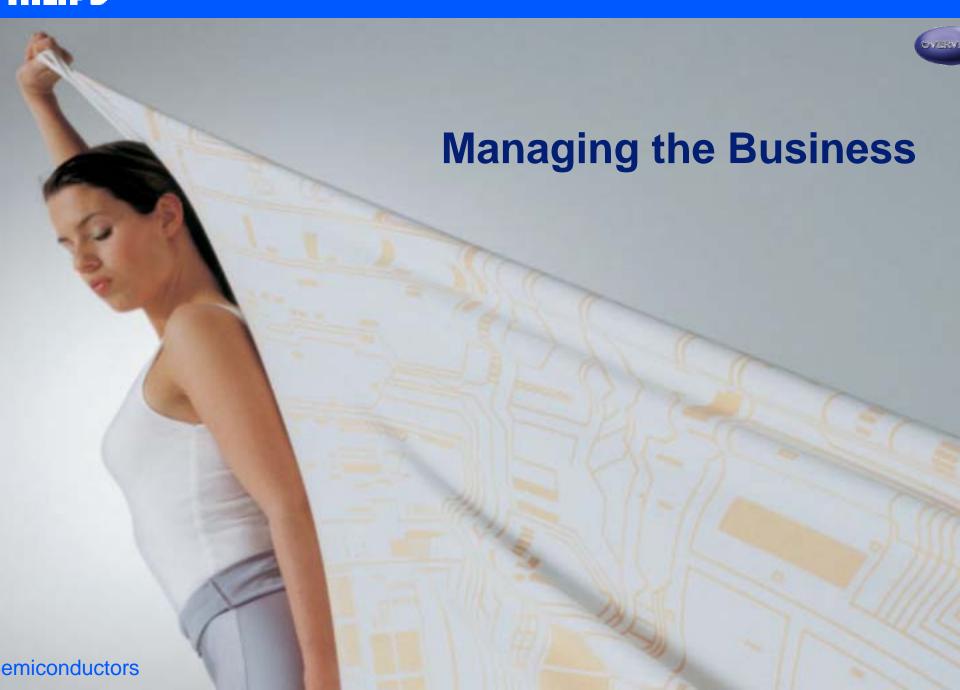
- All manufacturing sites have ISO14001
- We were the first semiconductor company to publish full details on the chemical substances in its products.
 Now the data are available on internet
- We are introducing a sustainability program now, publishing the first annual report in 2003



Environmental vision

- Building on our successes so far, our 2005 targets for environmental program:
 - Seven Green Flagship products per annum
 - Recycle 70% of waste*
 - Reduce energy consumption by 20% *
 - Reduce water consumption by 20% *
 - Reduce category 1 emissions to zero
 - Mandatory eco-design procedures for all products and processes

^{*} baseline year is 2001





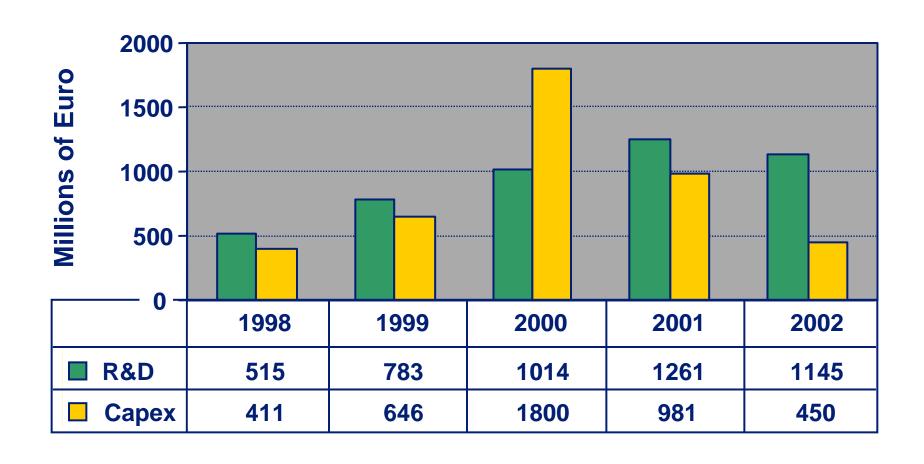
Managing the downturn

- Ongoing cost reductions
- Shortening the supply chain
- Efficiency and effectiveness in R&D
- Reducing inventory
- Improved planning
- Lowering our break-even point





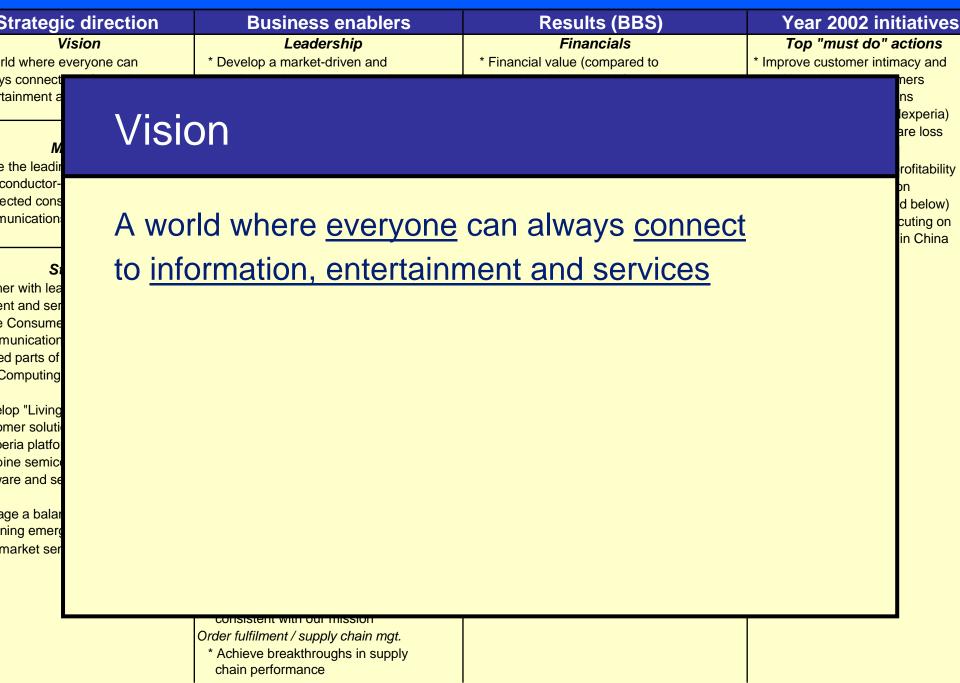
Investing for future revenues

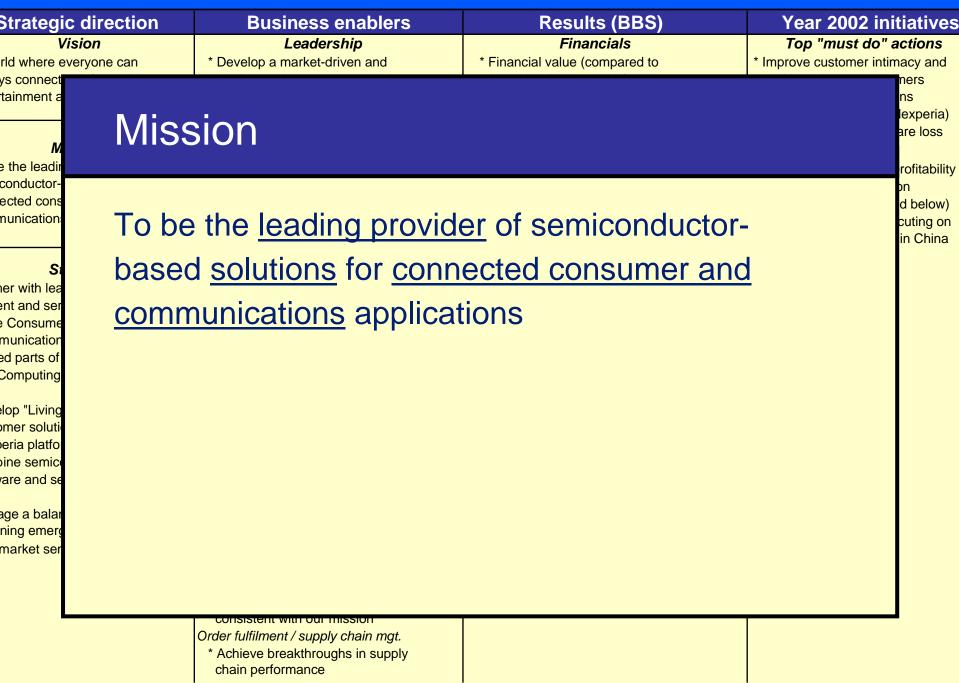


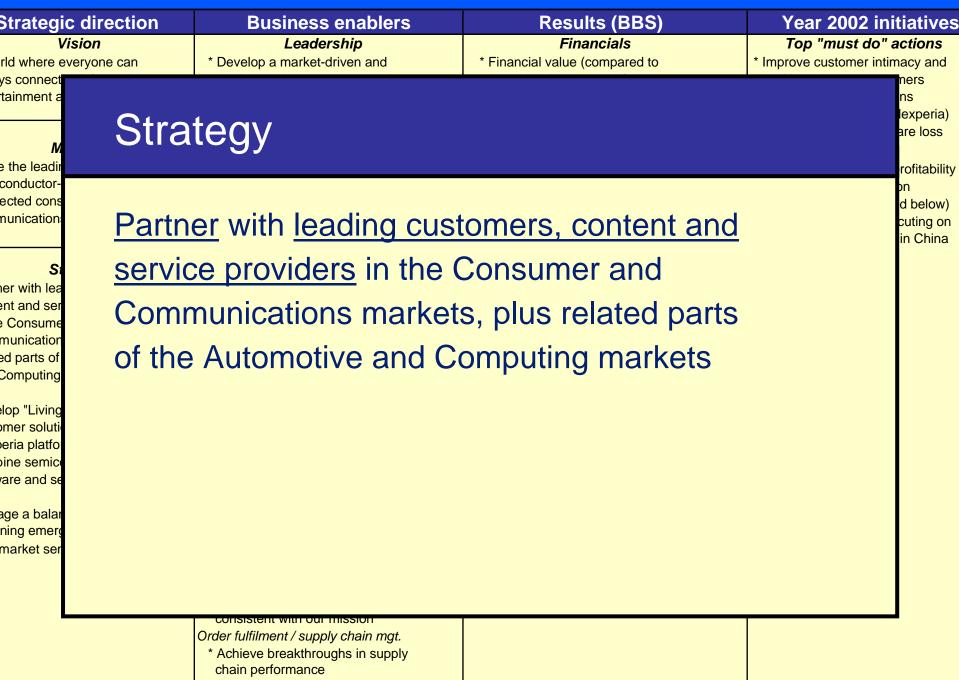


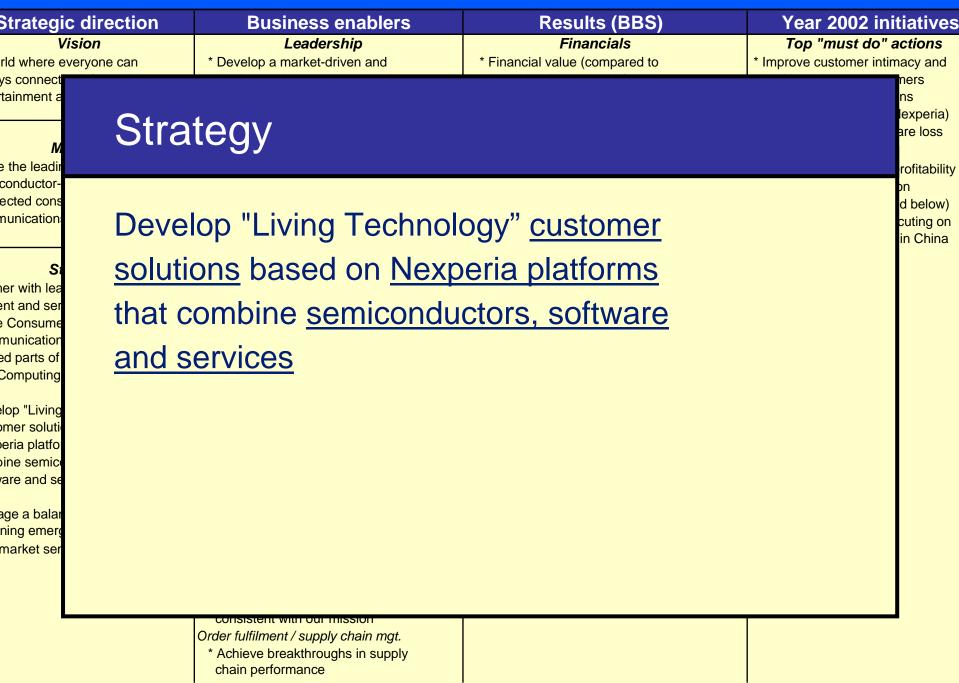
emiconductors

Strategic direction	Business enablers	Results (BBS)	Year 2002 initiatives
Vision rld where everyone can ys connect to information, tainment and services	* Develop a market-driven and continuous improvement mindset * Nurture an open two-way communication with our employees and other stakeholders	* Financials * Financial value (compared to benchmark companies) * Sales at key customers	* Improve customer intimacy and ranking with key customers * Realize more design wins (including ASICs and Nexperia) * Reverse our market share loss
Mission the leading provider of conductor-based solutions for ected consumer and nunications applications		* Market share * Design wins * Customer ranking and * Press coverage	
Strategy ner with leading customers, ent and service providers consumer and munications markets, plus ed parts of the Automotive Computing markets lop "Living Technology" omer solutions based on peria platforms that pine semiconductors,	* Actively tune the portfolio to outgrow competition * Increase our presence in China * Clearly prior cost	* Market share * Design wins * Customer ranking and * Press coverage processes mt / supply chain mgt. acked lead time * Flexibility to changes in demand Competence	
rare and services age a balanced portfolio ning emerging, mature and market semiconductors	* Achieve breakthroughs in supply chain performance	Competence (People, partnerships, technology, improvement) * Employee satisfaction & motivation * Size and quality of talent pool * PBE score * Patents	

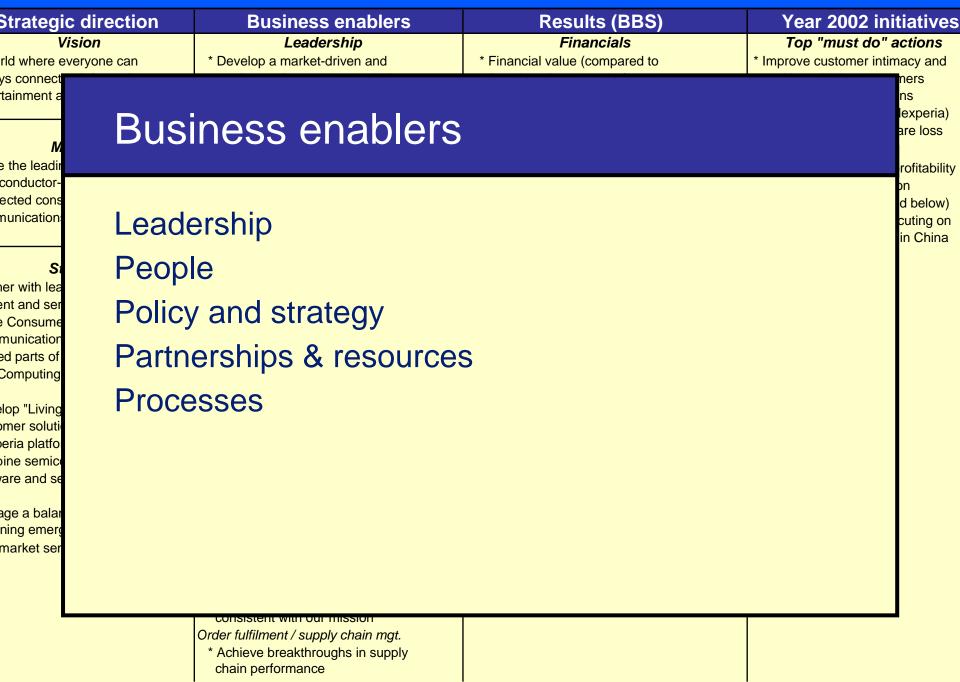


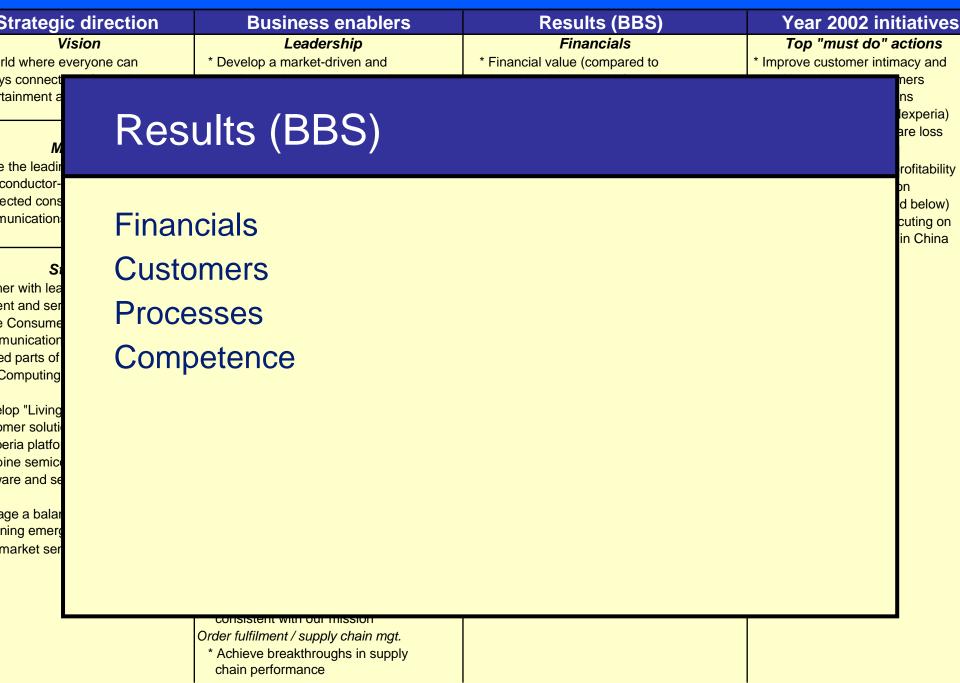


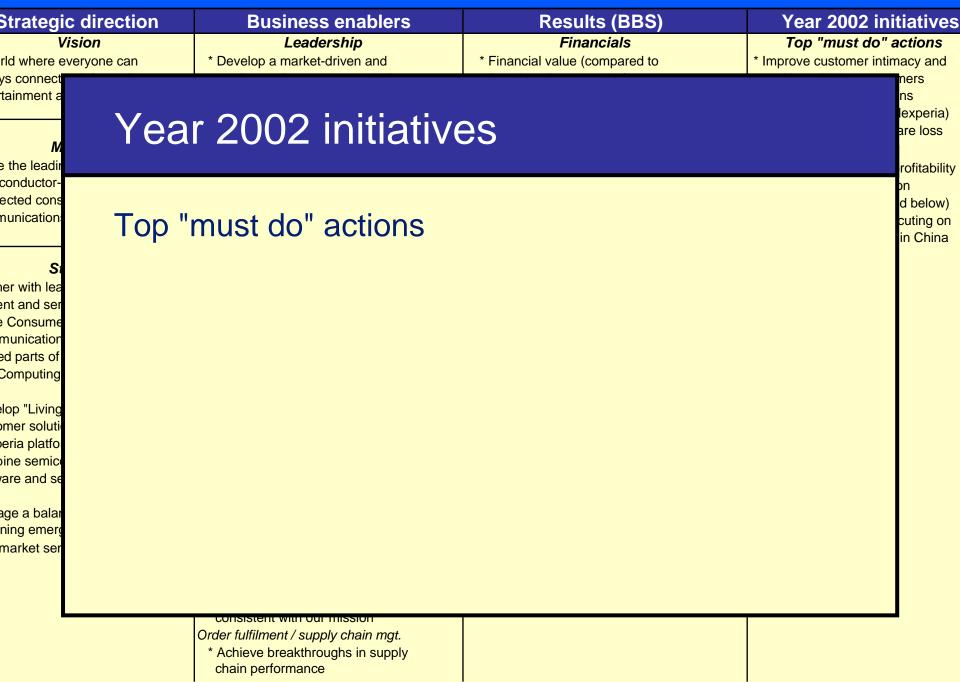




Strategic d	lirection	Business enablers	Results (BBS)	Year 2002 initiatives
Visional Vis	on	Leadership * Develop a market-driven and	Financials * Financial value (compared to	Top "must do" actions * Improve customer intimacy and
ys connect tainment a	Stra			ners ns lexperia) are loss rofitability
conductor- ected cons nunications Siner with leadent and ser Consume munication ed parts of Computing elop "Living omer solution oria platfo oine semicor vare and ser age a balar ning emerg market ser	emer	ge a balanced port ging, <u>mature</u> and <u>m</u> conductors		on d below) cuting on in China
		Order fulfilment / supply chain mgt. * Achieve breakthroughs in supply chain performance		









Customer intimacy is essential

- Today 55% of our revenue comes from our strategic customers
- By 2005 this needs to grow to 70%
 - Create long term design partnerships with these key players
 - Increase market share at these customers
 - Move many smaller customers to our distributors
- Partner with leading content and service providers
 - Establish standards
 - Examples: Visa, DTV-IA





lanage financial & IP risks

Strategic direction	Business enablers	Resu
Vision	Leadership	Fi
world where everyone can	* Develop a market-driven and	* Mark et share,
vays connect to information,	continuous improvement mindset	
tertainment and services.	* Nurture an open two-way	* Revenue, 2,0
lany customers will move their	communication with our employees	
nanufacturing operations into China	People * Recruit, develop and retain a divand talented team of people * Actively to out Poli * Actively to out Processes Mand creation * Define a list of key customers and manage these customers * Co-develop with upstream customers	
Mission		4C
be the leading provider of	People	1013
miconductor-based solutions for	* Recruit, develop and retain a div	~*())
nnected mass market consumer	and talented team of peopl	
d communications applications in	* Create internal growth	~
ina. We will contribute to Chinese	Poli	400
rive to prosperity	* Actively *	-0169
Strategy	OUT	1
Frow our China MS from 5% to 7-9% in 2		ation
	CONTRACT	ocess matur
artner with leading customers		* Customer intim
ntent and service provider	Sonling	* Driving standar
the Connected Cone		New product / syst
mmunications	our	* Design product
<mark>v-cost, mass-</mark>	gy, manufac-	products
<mark>portunities</mark>	s to customers	
		Order fulfilment / s
Engage in Chines	Processes	* Stacked lead t
generate long-terr	mand creation	* Flexibility to ch
	* Define a list of key customers and	
trategic areas of fo	manage these customer relations	
ndsets, mobile displ	* Co-develop with upstream customers	Col
plays, color TV, cordiess,	* Enhance external communication	(People, partnership
ital STB, identification, DTV	New product / system creation	* Employee satis
d multimarket semis.	* Unlock the value potential of our	* Size and qualit
	software capability in silicon	* PBE score
lse ASMC for low-cost non-	* Create new business opportunities	* IP managemen
ding edge technologies and	consistent with our mission	
indard processes	Order fulfilment / supply chain mgt.	
	* Achieve breakthroughs in supply	

chain performance

Results (BBS) **Financials**

ocesses

share, 7-9% in 2005

- B\$ in 2005

yalty

ers

maturity

- er intimacy standardization
- t / system creation
- productivity/drive low-cost

nent / supply chain mgt.

- lead time
- ty to changes in demand

Competence

- rtnerships, technology, improvement ee satisfaction & motivation
- d quality of talent pool
 - agement; royalties, licensing





LIPS









Manufacturing strategy

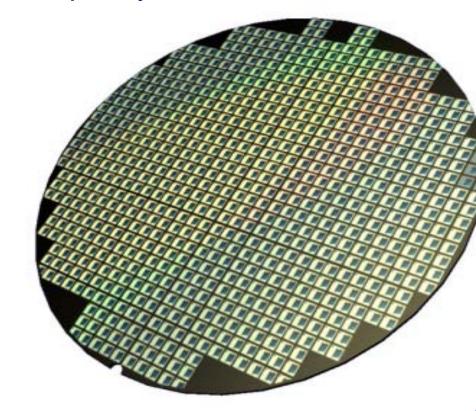
Our strategy for manufacturing is 'asset light'

For CMOS we will only increase capacity as a JV

or by outsourcing

 For speciality technologies (e.g. QUBiC, powerMOS) we will continue to invest

 Increase the proportion of outsourcing to >30% (40% for advanced technologies, and 50% for 120 nm and below)





Crolles - leaders in process technology

- Breakthrough in advanced semiconductor manufacturing
- With Motorola, ST and TSMC we represent a \$20 billion business
- Creating industry's leading-edge processes
- Together we'll invest \$1.4 bn by 2005, of which Philips' share is \$430 m
- Benefits
 - cutting-edge process technology
 - at an affordable price
 - compatibility across all alliance fabs
 - allows load sharing and outsourcing
 - flexibility to invest in new fabs when the volumes are proven





Technology platforms

Our key differentiator is the use of platforms to achieve solutions in Connected Consumer and Communication applications



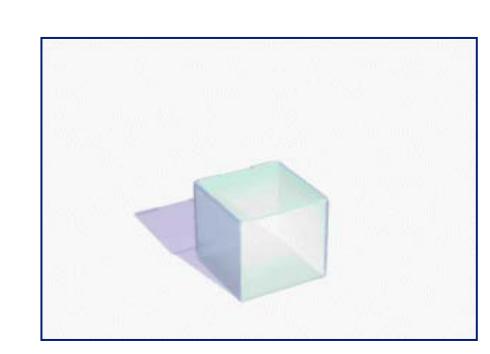
Shipping millions of Nexperia solutions since October 2001



What is a technology platform?

- Plug and play customisable solution created with intelligent architecture and a library of IP blocks
- Contains software and firmware

Reconfigurable





 3 top global TV makers have hundreds of design engineers working with our Nexperia DVP for 2003 digital TVs

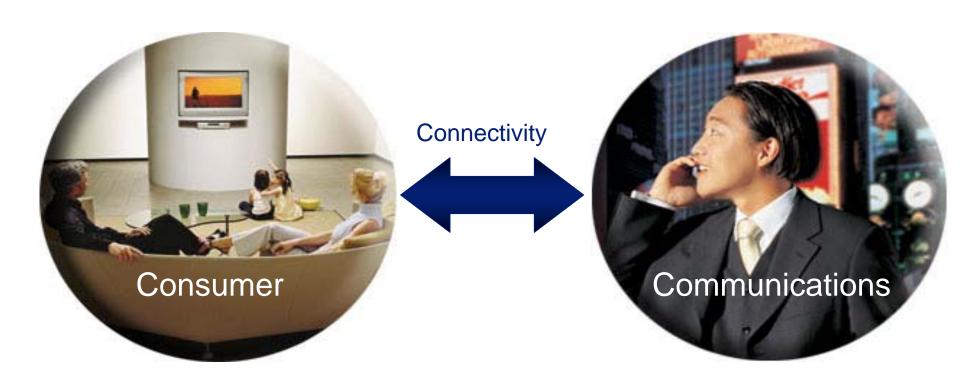
 Samsung and other leading mobile phone makers have selected our Nexperia system solution for 2002/3 phones







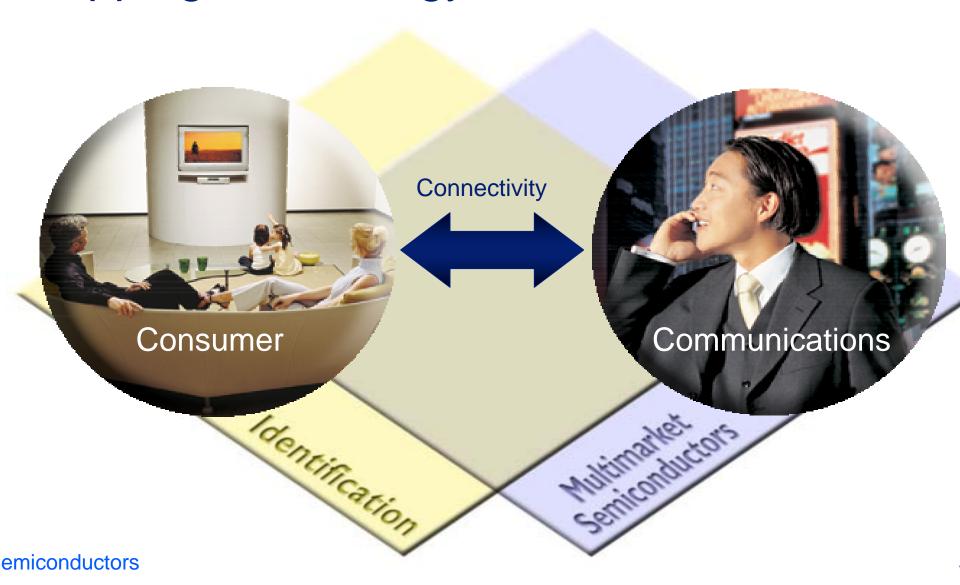
Mapping the strategy to our businesses





STRUM

Mapping the strategy to our businesses



Winning products for growing markets

STRA

- DVD+RW
- Digital TV
- Display system solutions
- Connectivity
- Identification
- Cellular system solutions































